



Our Docket No.: 042390.P9043

RESPONSE UNDER 37 C.F.R. § 1.116
- EXPEDITED PROCEDURE -
EXAMINING GROUP 2100

AF
IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Subramaniyam

Application No.: 09/669,034

Filed: September 25, 2000

For: A Method and Apparatus for Lowering)
the Die Temperature of a)
Microprocessor and Maintaining the)
Temperature Below the Die Burn Out)

Examiner: Phan, Raymond Ngan

Art Group: 2111

Enter with RCE 2-13-06

Phan
2-23-06

RESPONSE AFTER FINAL

Mail Stop: AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Final Office Action mailed on November 16, 2005, which was made final, applicant submits this Amendment After Final Action for consideration.

FIRST CLASS CERTIFICATE OF MAILING/FACSIMILE

I hereby certify that I am causing the above-referenced correspondence to be facsimile transmitted and to be deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and that this paper or fee has been addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

January 17, 2006

Date of Deposit

Leah Schwenke

Name of Person Mailing Correspondence

Signature

January 17, 2006

Date

Docket No.: 042390.P9043
Application No.: 09/669,034